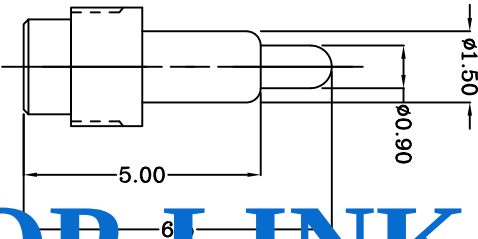
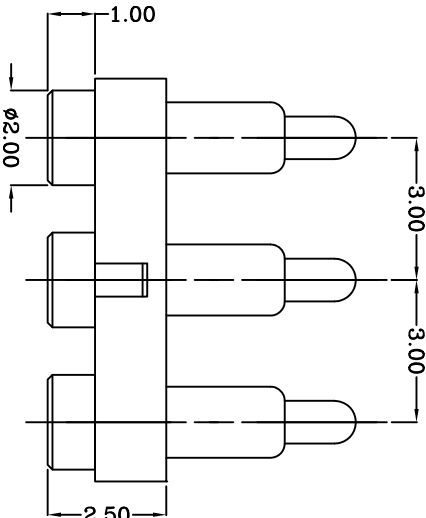
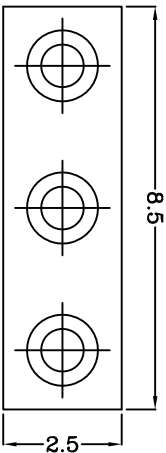
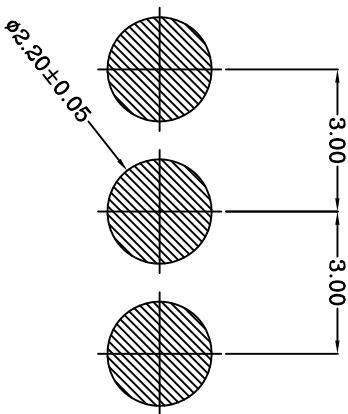


DWG NO.
C-110227



TOP-LINK



Recommended PCB Layout
Recommended solder paste thickness is 0.10 mm

- Notes:
- 1 Material, Housing: PA 4,6 (30% Glass Filled)
Color Black.
Contact: Brass
 - 2 Mechanical demands:
Plating Plunger: 0.4um Au over 1.4um Ni
Plating Body: 0.1um Au over 1.4um Ni.

LDC
-
DIST
-

	update remark		8087/18/21
LTR	REVISION RECORD	APVD	DATE

DIMENSIONS IN MM TOLERANCES UNLESS OTHER SPECIFIED			
0	= ±		
0.0	= ±0.15		
0.00	= ±0.10		
0.000	= ±		
ANGLE: ±1°			
SURF TEXTURE: 32/			
REMOVE BURRS, BREAK			
SHARP EDGES R0.05 MAX			
DO NOT SCALE PRINT			
MATL	HT TR	FIN	
DWN	APVD		
Benny	Lansing		
CHK	REL		
Andy			
NAME	POGO 3P		
SCALE	PGC-1.5-6.5-R-3P-3.0PH		
1:1	DWG NO. C-110227		
A4	SHEET 1 OF 1		
REV	B		

110227-3
PART NUMBER

Top-Link
Electronics L td.

USED ON

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